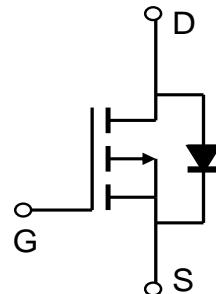


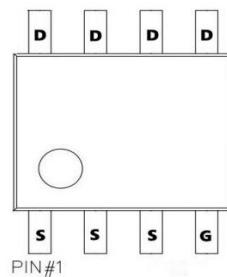
### General Description

- Latest Advanced Trench Technology
- Low  $R_{DS(ON)}$
- High Current Capability
- RoHS and Halogen-Free Compliant



### Product Summary

|                                   |          |
|-----------------------------------|----------|
| $V_{DS}$                          | -30V     |
| $I_D$ (at $V_{GS}=-10V$ )         | -14A     |
| $R_{DS(ON)}$ (at $V_{GS}=-10V$ )  | < 11.5mΩ |
| $R_{DS(ON)}$ (at $V_{GS}=-4.5V$ ) | < 18.5mΩ |



### Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

| Parameter                               | Symbol         | Maximum    | Units |
|---|----------------|------------|-------|
| Drain-Source Voltage                    | $V_{DS}$       | -30        | V     |
| Gate-Source Voltage                     | $V_{GS}$       | $\pm 25$   | V     |
| Continuous Drain Current                | $I_D$          | -14        | A     |
| $T_A=70^\circ C$                        |                | -11        |       |
| Pulsed Drain Current <sup>C</sup>       | $I_{DM}$       | -56        |       |
| Avalanche Current <sup>C</sup>          | $I_{AS}$       | -33        | A     |
| Avalanche energy $L=0.1mH$ <sup>C</sup> | $E_{AS}$       | 54         | mJ    |
| Power Dissipation <sup>B</sup>          | $P_D$          | 3.1        | W     |
| $T_A=25^\circ C$                        |                | 2.0        |       |
| Junction and Storage Temperature Range  | $T_J, T_{STG}$ | -55 to 150 | °C    |

### Thermal Characteristics

| Parameter  | Symbol    | Typ | Max | Units |
|--|-----------|-----|-----|-------|
| Maximum Junction-to-Ambient <sup>A</sup><br>$t \leq 10s$   | $R_{QJA}$ | 31  | 40  | °C/W  |
| Maximum Junction-to-Ambient <sup>A,D</sup><br>Steady-State |           | 59  | 75  | °C/W  |
| Maximum Junction-to-Lead                                   | $R_{QJL}$ | 16  | 24  | °C/W  |

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

| Symbol                      | Parameter                             | Conditions  | Min                    | Typ  | Max      | Units            |
|-----------------------------|---------------------------------------|---|------------------------|------|----------|------------------|
| <b>STATIC PARAMETERS</b>    |                                       |   |                        |      |          |                  |
| $BV_{DSS}$                  | Drain-Source Breakdown Voltage        | $I_D=-250\mu\text{A}, V_{GS}=0\text{V}$                                   | -30                    |      |          | V                |
| $I_{DSS}$                   | Zero Gate Voltage Drain Current       | $V_{DS}=-30\text{V}, V_{GS}=0\text{V}$                                    | $T_J=55^\circ\text{C}$ | -1   | -5       | $\mu\text{A}$    |
|                             |                                       |   |                        |      |          |                  |
| advanced                    | Gate-Body leakage current             | $V_{DS}=0\text{V}, V_{GS}=\pm25\text{V}$                                  |                        |      | $\pm100$ | nA               |
| $V_{GS(\text{th})}$         | Gate Threshold Voltage                | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$                                       | -1.3                   | -1.8 | -2.3     | V                |
| $R_{DS(\text{ON})}$         | Static Drain-Source On-Resistance     | $V_{GS}=-10\text{V}, I_D=-14\text{A}$                                     |                        | 9.5  | 11.5     | $\text{m}\Omega$ |
|                             |                                       | $V_{GS}=-4.5\text{V}, I_D=-10\text{A}$                                    |                        | 14.7 | 18.5     | $\text{m}\Omega$ |
| $g_{FS}$                    | Forward Transconductance              | $V_{DS}=-5\text{V}, I_D=-14\text{A}$                                      |                        | 42   |          | S                |
| $V_{SD}$                    | Diode Forward Voltage                 | $I_S=-1\text{A}, V_{GS}=0\text{V}$  |                        | -0.7 | -1       | V                |
| $I_S$                       | Maximum Body-Diode Continuous Current |   |                        |      | -4       | A                |
| <b>DYNAMIC PARAMETERS</b>   |                                       |   |                        |      |          |                  |
| $C_{iss}$                   | Input Capacitance                     | $V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$                     |                        | 2050 |          | pF               |
| $C_{oss}$                   | Output Capacitance                    |   |                        | 330  |          | pF               |
| $C_{rss}$                   | Reverse Transfer Capacitance          |   |                        | 300  |          | pF               |
| $R_g$                       | Gate resistance                       | $f=1\text{MHz}$   |                        | 3.2  | 6.4      | $\Omega$         |
| <b>SWITCHING PARAMETERS</b> |                                       |   |                        |      |          |                  |
| $Q_g(10\text{V})$           | Total Gate Charge                     | $V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, I_D=-14\text{A}$                 |                        | 40   | 60       | nC               |
| $Q_g(4.5\text{V})$          | Total Gate Charge                     |   |                        | 20   | 30       | nC               |
| $Q_{gs}$                    | Gate Source Charge                    |   |                        | 6    |          | nC               |
| $Q_{gd}$                    | Gate Drain Charge                     |   |                        | 10   |          | nC               |
| $t_{D(on)}$                 | Turn-On DelayTime                     | $V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=1.05\Omega, R_{GEN}=3\Omega$ |                        | 11   |          | ns               |
| $t_r$                       | Turn-On Rise Time                     |   |                        | 10   |          | ns               |
| $t_{D(off)}$                | Turn-Off DelayTime                    |   |                        | 40   |          | ns               |
| $t_f$                       | Turn-Off Fall Time                    |   |                        | 18   |          | ns               |
| $t_{rr}$                    | Body Diode Reverse Recovery Time      | $I_F=-14\text{A}, di/dt=500\text{A}/\mu\text{s}$                          |                        | 14   |          | ns               |
| $Q_{rr}$                    | Body Diode Reverse Recovery Charge    | $I_F=-14\text{A}, di/dt=500\text{A}/\mu\text{s}$                          |                        | 25   |          | nC               |

A. The value of  $R_{JJA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{ C}$ . The value in any given application depends on the user's specific board design.

B. The power dissipation  $P_0$  is based on  $T_{J(\text{MAX})}=150^\circ\text{ C}$ , using  $\leqslant 10\text{s}$  junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})}=150^\circ\text{ C}$ . Ratings are based on low frequency and duty cycles to keep initial  $T_J=25^\circ\text{ C}$ .

D. The  $R_{JJA}$  is the sum of the thermal impedance from junction to lead  $R_{JL}$  and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300 $\mu\text{s}$  pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, assuming a maximum junction temperature of  $T_{J(\text{MAX})}=150^\circ\text{ C}$ . The SOA curve provides a single pulse rating.

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

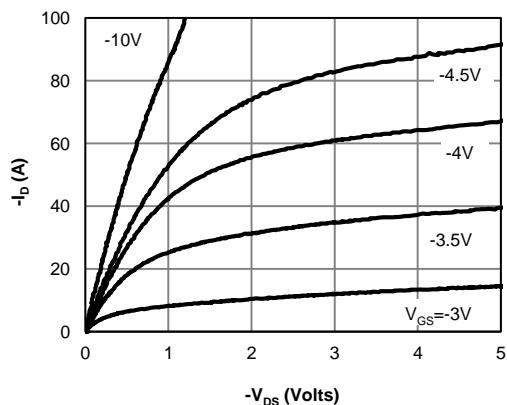


Figure 1: On-Region Characteristics (Note E)

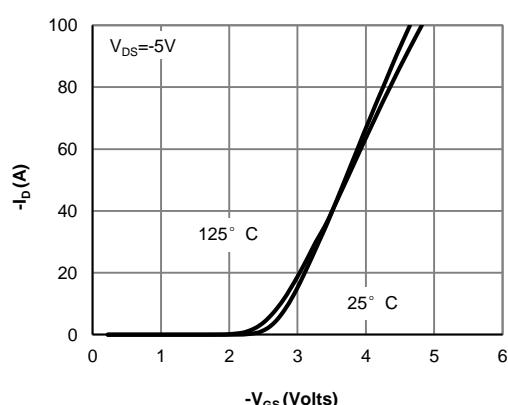


Figure 2: Transfer Characteristics (Note E)

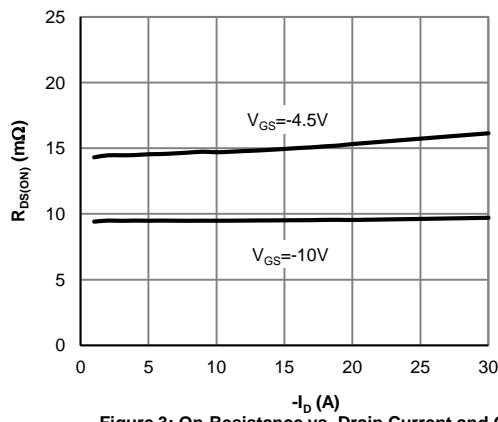


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

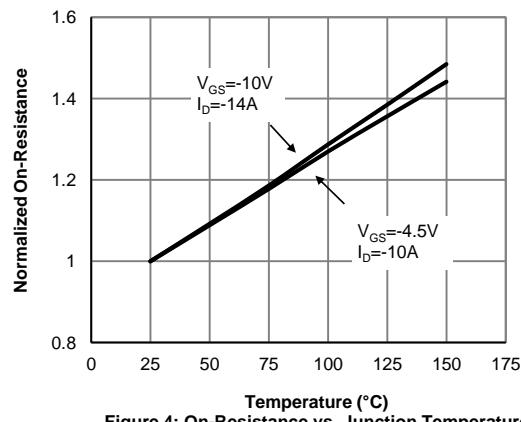


Figure 4: On-Resistance vs. Junction Temperature (Note E)

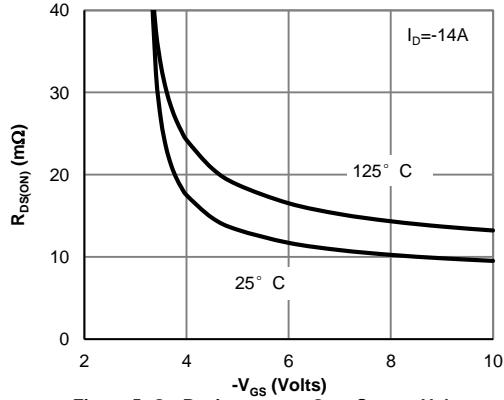


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

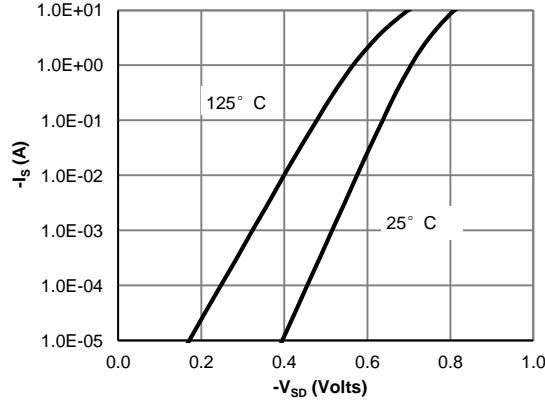


Figure 6: Body-Diode Characteristics (Note E)

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

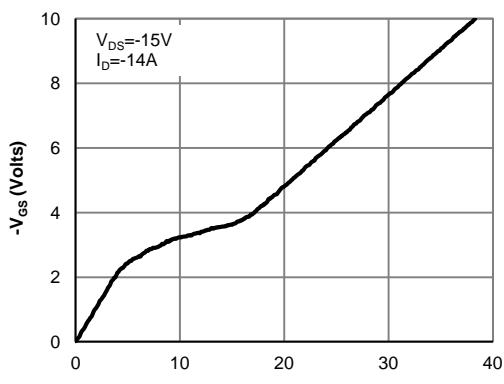


Figure 7: Gate-Charge Characteristics

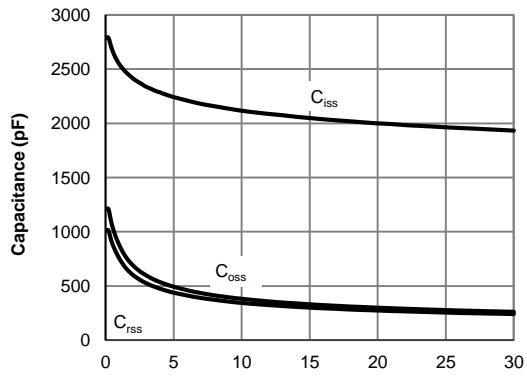


Figure 8: Capacitance Characteristics

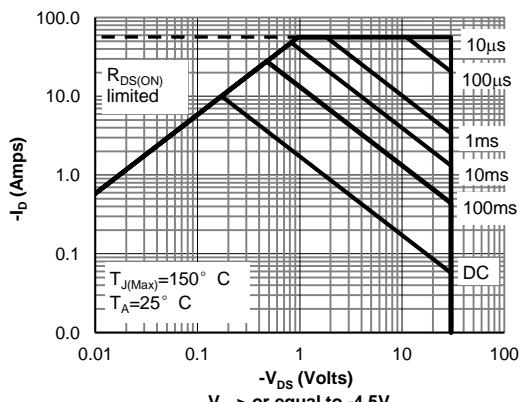


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

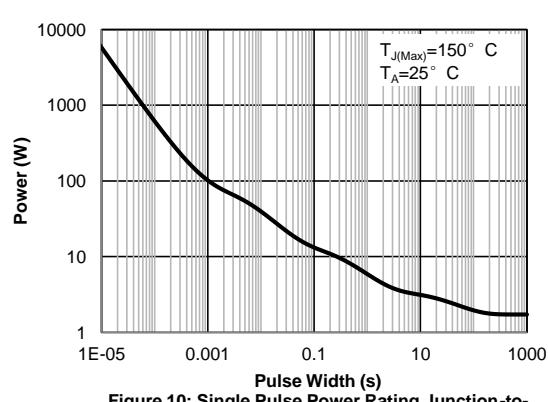


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

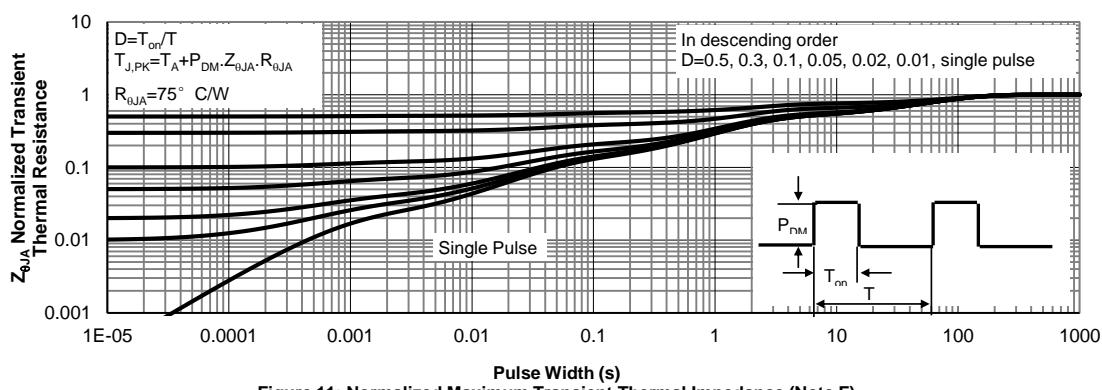
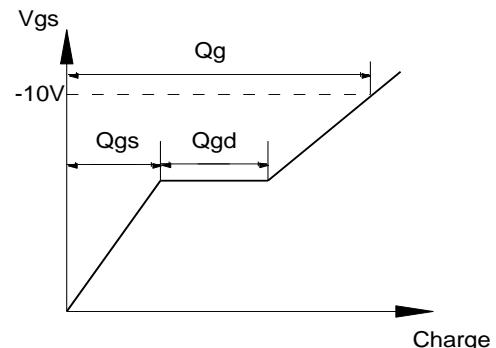
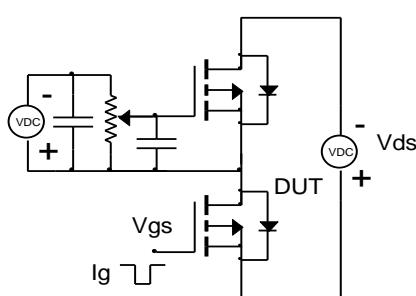
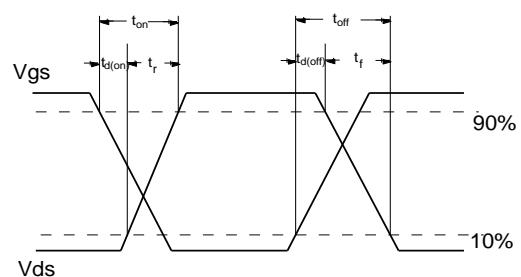
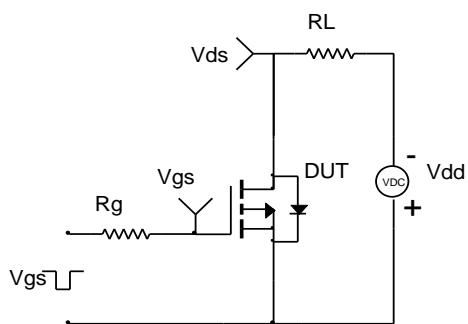


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

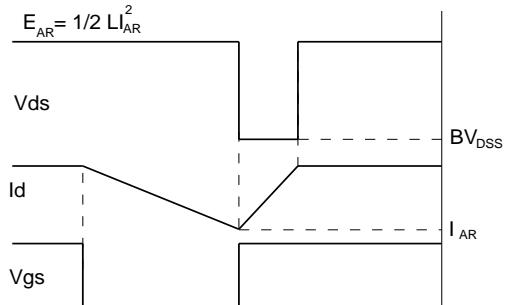
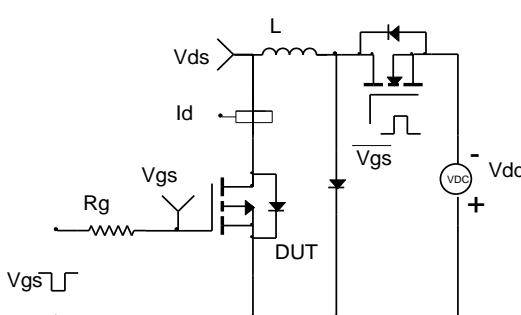
Gate Charge Test Circuit & Waveform



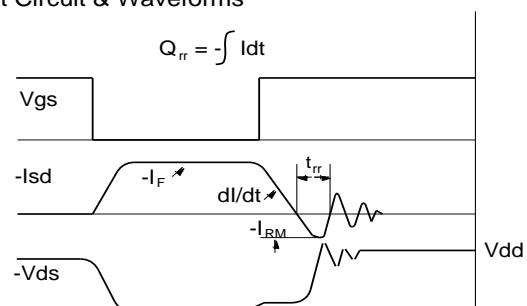
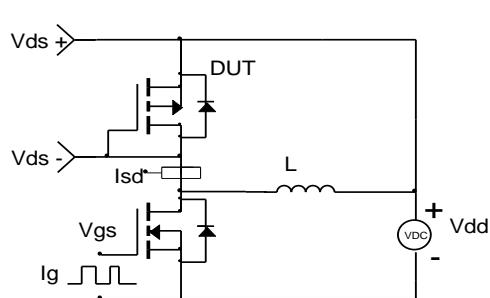
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

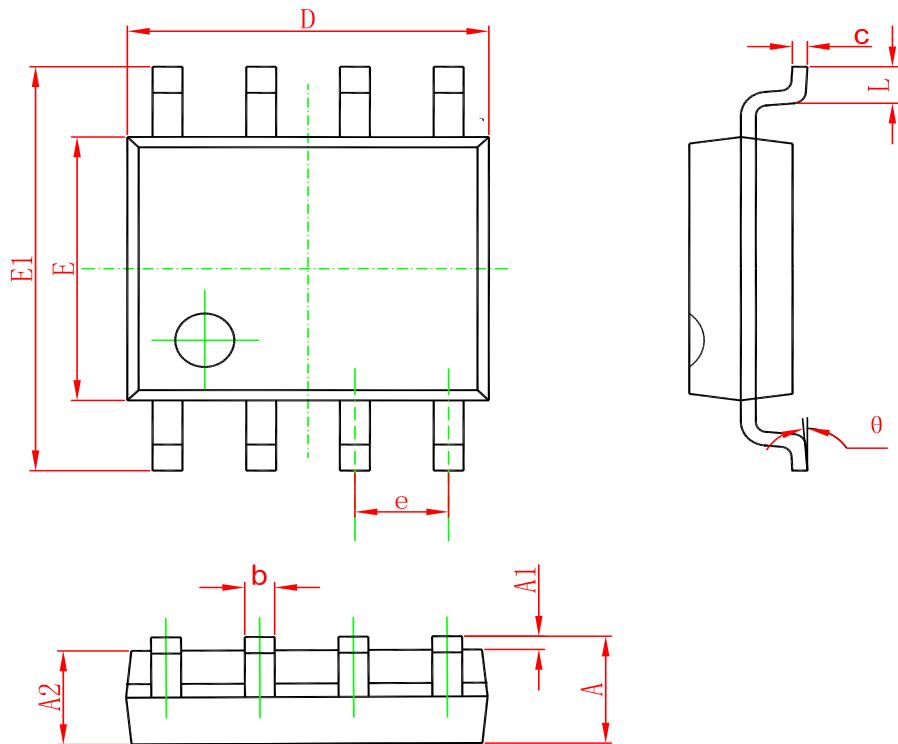


Diode Recovery Test Circuit & Waveforms



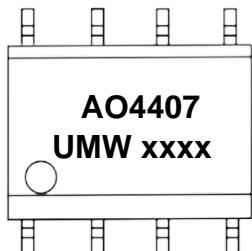
## PACKAGE OUTLINE DIMENSIONS

SOP-8



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 1.350                     | 1.750 | 0.053                | 0.069 |
| A1     | 0.100                     | 0.250 | 0.004                | 0.010 |
| A2     | 1.350                     | 1.550 | 0.053                | 0.061 |
| b      | 0.330                     | 0.510 | 0.013                | 0.020 |
| c      | 0.170                     | 0.250 | 0.006                | 0.010 |
| D      | 4.700                     | 5.100 | 0.185                | 0.200 |
| E      | 3.800                     | 4.000 | 0.150                | 0.157 |
| E1     | 5.800                     | 6.200 | 0.228                | 0.244 |
| e      | 1.270(BSC)                |       | 0.050(BSC)           |       |
| L      | 0.400                     | 1.270 | 0.016                | 0.050 |
| θ      | 0°                        | 8°    | 0°                   | 8°    |

## Marking



## Ordering information

| Order code  | Package | Baseqty | Deliverymode  |
|-------------|---------|---------|---------------|
| UMW AO4407A | SOP-8   | 3000    | Tape and reel |